





45V NPN MEDIUM POWER HIGH GAIN TRANSISTOR

Product Summary

BV _{CEO}	45V
R _{SAT}	77mΩ
I _C	3A

Description and Applications

Packaged in the TO252-3L/DPAK outline this high gain 45V NPN transistor offers low on state losses making it ideal for use in DC-DC circuits and various driving and power management functions.

- DC DC Converters
- MOSFET gate drivers
- Charging circuits
- Power switches
- Siren drivers

Features and Benefits

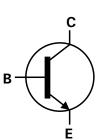
- 3 Amps continuous current
- Up to 6 Amps peak current
- Low saturation voltages
- High gain
- Lead, Halogen, and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

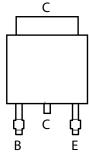
Case: TO252-3L/DPAK







Equivalent Circuit



Package Pin Configuration

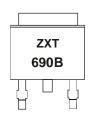
Ordering Information

Product	Marking	Reel size	Tape width	Quantity per reel
ZXT690BKTC	ZXT690B	13 in.	16mm embossed	2500 units

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com

Marking Information



ZXT690B = Product Type Marking Code





Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	BV _{CBO}	60	V
Collector-Emitter Voltage	BV _{CEO}	45	V
Emitter-Base Voltage	BV _{EBO}	5	V
Continuous Collector Current	Ic	3	Α
Peak Pulse Current	I _{CM}	6	Α
Base Current	I _B	0.5	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ T _A = 25°C Linear Derating Factor	P _D	2.1 16.85	W mW/°C
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ heta JA}$	59	°C/W
Power Dissipation (Note 4) @ T _A = 25°C Linear Derating Factor	P _D	3.0 24.4	W mW/°C
Thermal Resistance, Junction to Ambient (Note 2)	$R_{ heta JA}$	41	°C/W
Power Dissipation (Note 5) @ T _A = 25°C Linear Derating Factor	P _D	3.9 30.9	W mW/°C
Thermal Resistance, Junction to Ambient (Note 3)	$R_{ heta JA}$	32	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

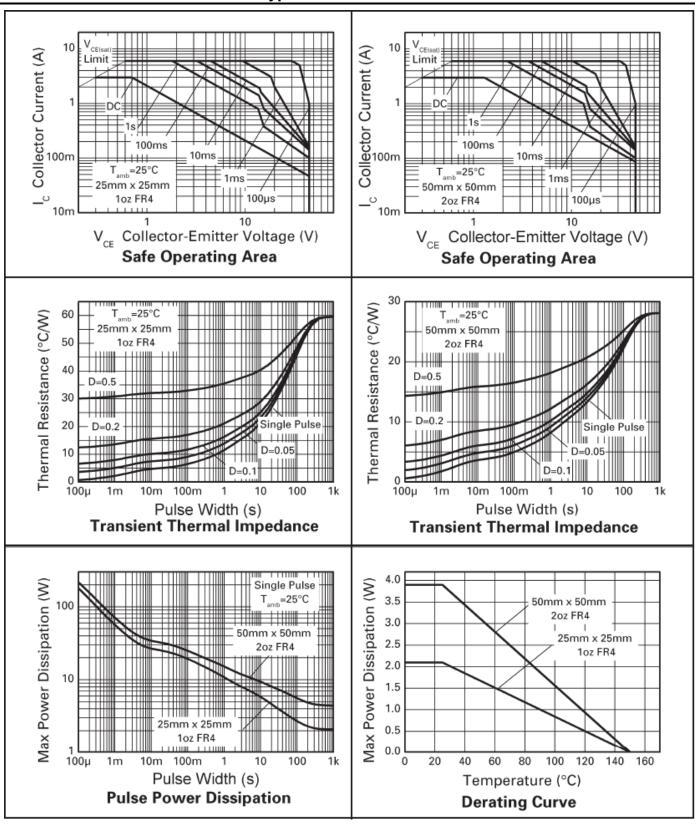
- 3. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

 4. For a device surface mounted on 50mm x 50mm FR4 PCB with high coverage of single sided 1oz copper in still air conditions.
- 5. For a device surface mounted on 50mm x 50mm FR4 PCB with high coverage of single sided 2oz copper in still air conditions.





Typical Characteristics







Electrical Characteristics @T_A = 25°C unless otherwise specified

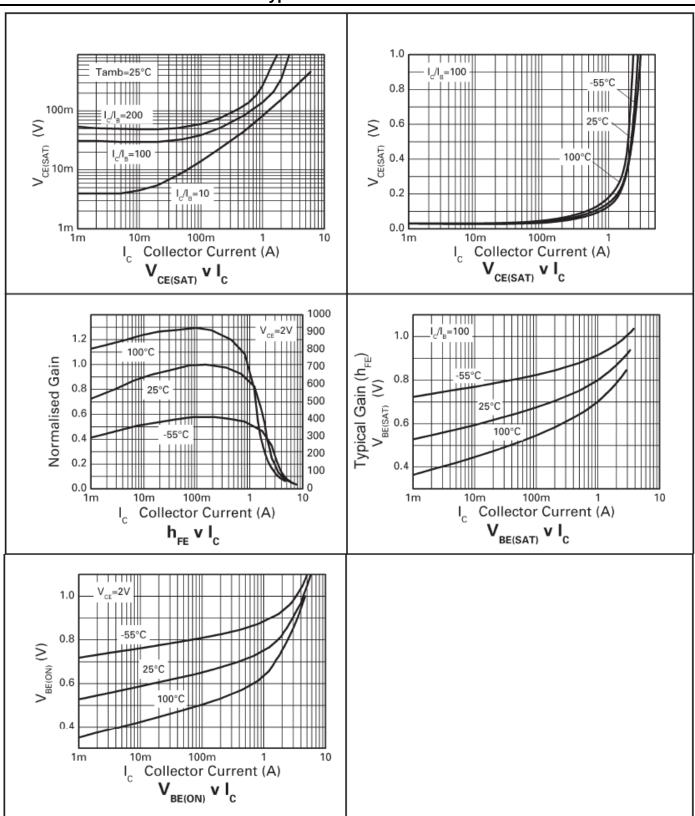
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	60	145	_	V	$I_C = 100 \mu A$
Collector-Emitter Breakdown Voltage (Note 6)	BV _{CEO}	45	65	_	V	I _C = 10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	5	8.2	_	V	$I_E = 100 \mu A$
Collector Cutoff Current	I _{CBO}	_	<1	20	nA	V _{CB} = 35V
Collector Cutoff Current	I _{CES}	_	<1	20	nA	V _{CB} = 35V
Emitter Cutoff Current	I _{EBO}	_	<1	20	nA	V _{EB} = 4V
	V _{CE(sat)}		50	85		I _C = 0.1A, I _B = 0.5mA
Collector Emitter Coturation Voltage (Note C)			240	360		I _C = 1A, I _B = 5mA
Collector-Emitter Saturation Voltage (Note 6)		_	210	320	mV	I _C = 2A, I _B = 40mA
			230	350		I _C = 3A, I _B = 150mA
Base-Emitter Saturation Voltage (Note 6)	V _{BE(sat)}	_	1.0	1.2	mV	I _C = 3A, I _B = 150mA
Base-Emitter Turn-On Voltage (Note 6)	V _{BE(on)}	_	0.9	1.1	mV	I _C = 3A, V _{CE} = 2V
	h _{FE}	500		_	_	I _C = 100mA, V _{CE} = 2V
DC Current Coin (Note 6)		400				I _C = 1A, V _{CE} = 2V
DC Current Gain (Note 6)		150				I _C = 2A, V _{CE} = 2V
		60				I _C = 3A, V _{CE} = 2V
Current Gain-Bandwidth Product	f _T	_	_	_	MHz	I _C = 50mA, V _{CE} = 5V, f = 50MHz
Output Capacitance (Note 6)	C _{obo}	_	16		pF	V _{CB} = 10V, f = 1MHz
Turn-On Time	t _{on}	_	33	_	ns	I _C = 500mA, V _{CC} = 10V,
Turn-Off Time	t _{off}	_	1300		ns	$I_{B1} = I_{B2} = 50 \text{mA}$

Notes: 6. Measured under pulsed conditions. Pulse width $\leq 300 \mu s$; duty cycle $\leq 2\%$.



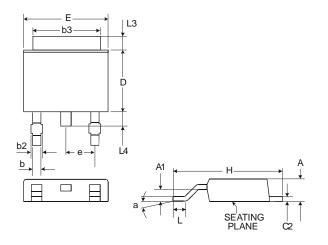


Typical Characteristics



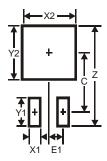


Package Outline Dimensions



TO252-3L				
Dim	Min	Тур	Max	
Α	2.19	2.29	2.39	
A1	0.97	1.07	1.17	
b	0.64	0.76	0.88	
b2	0.76	0.95	1.14	
b3	5.21	5.33	5.50	
C2	0.45	0.51	0.58	
D	6.00	6.10	6.20	
Е	6.45	6.58	6.70	
е	2.286 Typ.			
Н	9.40	9.91	10.41	
L	1.40	1.59	1.78	
L3	0.88	1.08	1.27	
L4	0.64	0.83	1.02	
а	0°	-	10°	
All Dimensions in mm				

Package Outline Dimensions



Dimensions	Value (in mm)
Z	11.6
X1	1.5
X2	7.0
Y1	2.5
Y2	7.0
С	6.9
E1	2.3





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